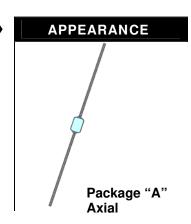
Microsemi SCOTTSDALE DIVISION

1N6620 thru 1N6625

VOIDLESS-HERMETICALLY SEALED ULTRA FAST RECOVERY GLASS RECTIFIERS

DESCRIPTION

This "Ultrafast Recovery" rectifier diode series is military qualified to MIL-PRF-19500/585 and is ideal for high-reliability applications where a failure cannot be tolerated. These industry-recognized 1.5 to 2.0 Amp rated rectifiers for working peak reverse voltages from 200 to 1000 volts are hermetically sealed with voidless-glass construction using an internal "Category I" metallurgical bond. These devices are also available in surface mount MELF package configurations by adding a "US" suffix (see separate data sheet for 1N6620US thru 1N6625US). Microsemi also offers numerous other rectifier products to meet higher and lower current ratings with various recovery time speed requirements including standard, fast and ultrafast device types in both through-hole and surface mount packages.



IMPORTANT: For the most current data, consult MICROSEMI's website: http://www.microsemi.com

FEATURES

- Popular JEDEC registered 1N6620 to 1N6625 series
- Voidless hermetically sealed glass package
- Extremely robust construction
- Triple-layer passivation
- Internal "Category I" Metallurgical bonds
- JAN, JANTX, and JANTXV available per MIL-PRF-19500/585
- Further options for screening in accordance with MIL-PRF-19500 for JANS by using a "SP" prefix, e.g. SP6620, SP6624, etc.
- Surface mount equivalents also available in a square end-cap MELF configuration with "US" suffix (see separate data sheet for 1N6620US thru 1N6625US)

MAXIMUM RATINGS

- Junction Temperature: -65°C to +150°C
- Storage Temperature: -65°C to +175°C
- Peak Forward Surge Current @ 25°C: 20 Amps (except 1N6625 which is 15 Amps)

Note: Test pulse = 8.3 ms, half-sine wave.

 Average Rectified Forward Current (I_O) at T_L= +55°C (L=.375 inch from body):

1N6620 thru 1N6622: 2.0 Amps 1N6623 thru 1N6625: 1.5 Amps

(Derate linearly at 0.833%/°C for $T_L > +55$ °C)

Average Rectified Forward Current (I_O) at T_A=25°C:

1N6620 thru 1N6622: 1.2 Amps 1N6623 thru 1N6625: 1.0 Amp

(Derate linearly at 0.67%/ °C for T_A>+25°C. This I_O rating is typical for PC boards where thermal resistance from mounting point to ambient is sufficiently controlled where T_{J(max)} is not exceeded.)

- Thermal Resistance L= 0.375 inch (R_{θJL}): 38°C/W
- Capacitance at V_R= 10 V: 10 pF
- Solder temperature: 260°C for 10 s (maximum)

APPLICATIONS / BENEFITS

- Ultrafast recovery rectifier series 200 to 1000 V
- Military and other high-reliability applications
- Switching power supplies or other applications requiring extremely fast switching & low forward loss
- High forward surge current capability
- Low thermal resistance
- Controlled avalanche with peak reverse power capability
- Inherently radiation hard as described in Microsemi MicroNote 050

MECHANICAL AND PACKAGING

- CASE: Hermetically sealed voidless hard glass with Tungsten slugs
- TERMINATIONS: Axial-leads are Copper with Tin/Lead (Sn/Pb) finish
- MARKING: Body painted and part number, etc.
- POLARITY: Cathode indicated by band
- Tape & Reel option: Standard per EIA-296
- Weight: 340 mg
- See package dimensions on last page

1N6620 thru 1N6625



VOIDLESS-HERMETICALLY SEALED ULTRA FAST RECOVERY GLASS RECTIFIERS

티	ELECTRICAL CHARACTERISTICS @25°C											
-	YPE	MINIMUM	MAXII		WORKING	MAXI	-	MAXIMUM	MAXIMUM	PEAK	FORWARD	
NU	MBER	BREAK-	FORW		PEAK	REVE		REVERSE	REVERSE	RECOVERY	RECOVERY	
		DOWN	VOLT		REVERSE	CURRE	NT I _R @	RECOVERY	RECOVERY	CURRENT	VOLTAGE	
		VOLTAGE V _F @ I _F		VOLTAGE		νM	TIME (LOW	TIME (HIGH	I _{RM} (rec)	V _{FRM} Max		
		V_R			V_{RWM}	I _R		CURRENT)	CURRENT)	$I_F = 2A$,	$I_F = 0.5A$	
		$I_R = 50 \mu A$				T _A =25°C	T _A =150°C	t _{rr}	t _{rr}	100A/μs	t _{fr} =12ns	
						,	Α	Note 1	Note 2	Note 2		
		٧	V @ A	V @ A	٧	μΑ	μΑ	ns	ns	Α	V	
1N	16620	220	1.40V @ 1.2A	1.60V @ 2.0A	200	0.5	150	30	45	3.5	12	
1N	16621	440	1.40V @ 1.2A	1.60V @ 2.0A	400	0.5	150	30	45	3.5	12	
1N	16622	660	1.40V @ 1.2A	1.60V @ 2.0A	600	0.5	150	30	45	3.5	12	
1N	16623	880	1.55V @ 1.0A	1.80V @ 1.5A	800	0.5	150	50	60	4.2	18	
1N	16624	990	1.55V @ 1.0A	1.80V @ 1.5A	900	0.5	150	50	60	4.2	18	
1N	16625	1100	1.75V @ 1.0A	1.95V @ 1.5A	1000	1.0	200	60	80	5.0	30	

NOTE 1: Low Current Reverse Recovery Time Test Conditions: I_F=0.5A, I_{RM}=1.0A, I_{R(REC)} = 0.25A per MIL-STD-750, Method 4031, Condition B.

NOTE 2: High Current Reverse Recovery Time Test Conditions: I_F = 2 A, di/dt=100 A/μs MIL-STD-750, Method 4031, Condition D.

	SYMBOLS & DEFINITIONS								
Symbol	Definition								
V_{BR}	Minimum Breakdown Voltage: The minimum voltage the device will exhibit at a specified current.								
V_{RWM}	Working Peak Reverse Voltage: The maximum peak voltage that can be applied over the operating temperature range.								
V_{F}	Maximum Forward Voltage: The maximum forward voltage the device will exhibit at a specified current.								
I _R	Maximum Reverse Current: The maximum reverse (leakage) current that will flow at the specified voltage and temperature.								
С	Capacitance: The capacitance of the TVS as defined @ 0 volts at a frequency of 1 MHz and stated in picofarads.								
t _{rr}	Reverse Recovery Time: The time interval between the instant the current passes through zero when changing from the forward direction to the reverse direction and a specified recovery decay point after a peak reverse current is reached.								

CHARTS AND GRAPHS

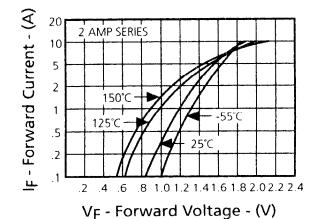
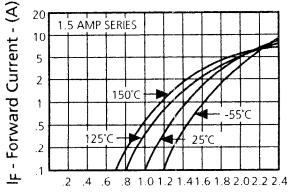


FIGURE 1
Typical Forward Current
vs
Forward Voltage



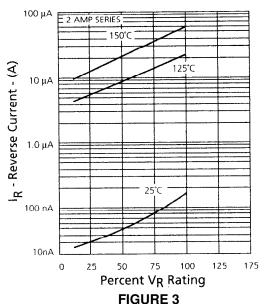
V_F - Forward Voltage - (V)
FIGURE 2

Typical Forward Current vs Forward Voltage



1N6620 thru 1N6625

VOIDLESS-HERMETICALLY SEALED ULTRA FAST RECOVERY GLASS RECTIFIERS



Typical Reverse Current vs.
Applied Reverse Voltage

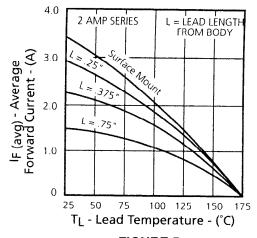


FIGURE 5
Average Forward Current vs.
Lead Temperature (50% Duty Cycle, Square Wave)

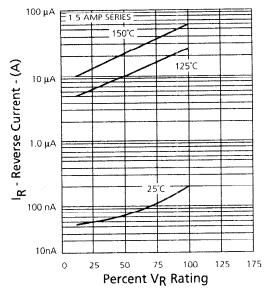


FIGURE 4
Typical Reverse Current vs.
Applied Reverse Voltage

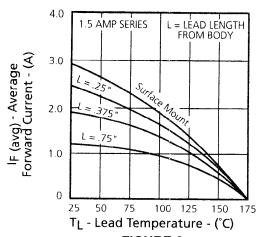
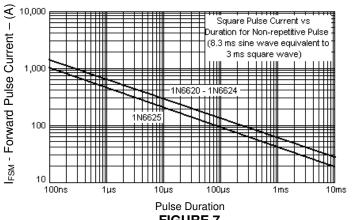


FIGURE 6
Average Forward Current vs
Lead Temperature (50% Duty Cycle, Square Wave)



1N6620 thru 1N6625

VOIDLESS-HERMETICALLY SEALED ULTRA FAST RECOVERY GLASS RECTIFIERS



P_R – Reverse Pulse Power – (W) ALL SERIE Duration for Non-repetitive Pulse 1 (8.3 ms sine wave equivalent to 1,000 100 10 100ns 1µs **Pulse Duration**

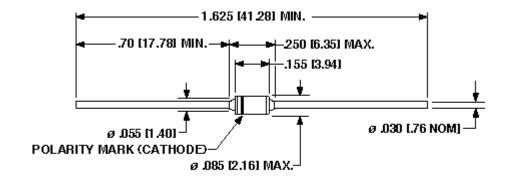
FIGURE 8 Reverse Pulse Power vs. Pulse Duration

Square Pulse Current vs

FIGURE 7 Forward Pulse Current vs. **Pulse Duration**

PACKAGE DIMENSIONS

10,000



NOTE: DIMENSIONS IN INCHES [mm]

Lead tolerance = +0.002/-0.003 inches